

Reference Specification

Leaded MLCC for Automotive with AEC-Q200 RCE Series

Product specifications in this catalog are as of Apr. 2022, and are subject to change or obsolescence without notice.

Please consult the approval sheet before ordering. Please read rating and Cautions first.

⚠ CAUTION

1. OPERATING VOLTAGE

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range. When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.

When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for each equipment should be taken into considerations.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage(1)	Pulse Voltage(2)
Positional Measurement	Vo-p	Vo-p	Vp-p	Vp-p	Vp-p

2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. In case of Class 2 capacitors (Temp.Char.: X7R,X7S,X8L, etc.), applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C. Please contact us if self-generated heat is occurred with Class 1 capacitors (Temp.Char.: C0G,U2J,X8G, etc.). When measuring, use a thermocouple of small thermal capacity-K of Φ0.1mm and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability.

3. FAIL-SAFE

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

4. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed 5 to 40 °C and 20 to 70%. Use capacitors within 6 months.

5. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

6. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

7. BONDING AND RESIN MOLDING, RESIN COAT

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of a bonded or molded product in the intended equipment. In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive or molding resin may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

8. TREATMENT AFTER BONDING AND RESIN MOLDING, RESIN COAT

When the outer coating is hot (over 100 $^{\circ}$ C) after soldering, it becomes soft and fragile. So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9. LIMITATION OF APPLICATIONS

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

Aircraft equipment

2. Aerospace equipment

3. Undersea equipment

4. Power plant control equipment

5. Medical equipment

- 6. Transportation equipment (vehicles, trains, ships, etc.)
- 7. Traffic signal equipment
- 8. Disaster prevention / crime prevention equipment
- 9. Data-processing equipment exerting influence on public
- 10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. SOLDERING AND MOUNTING

Insertion of the Lead Wire

- When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.
- Insert the lead wire into the PCB with a distance appropriate to the lead space.

3. CAPACITANCE CHANGE OF CAPACITORS

• Class 2 capacitors (Temp.Char. : X7R,X7S,X8L etc.)

Class 2 capacitors an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit

Please contact us if you need a detail information.

⚠ NOTE

- 1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. You are requested not to use our product deviating from this specification.

1. Application

This specification is applied to Leaded MLCC RCE series in accordance with AEC-Q200 requirements used for Automotive Electronic equipment.

2. Rating

Part Number Configuration

ex.)	RCE	7U	2E	101	J	1	K1	H03	В
	Series	Temperature	Rated	Capacitance	Capacitance	Dimension	Lead	Individual	Package
		Characteristics	Voltage		Tolerance	(LxW)	Style	Specification	

• Temperature Characteristics

Code	Temp. Char.	Temp. Range	Temp.coef.	Standard Temp.	Operating Temp. Range	
711	U2J	-55∼25°C	-750+120/-347ppm/°C	25°C	-55 ∼ 125°C	
70	(EIA code)	25∼125°C	-750+/-120ppm/°C	25 C	-55.9 125 C	

Rated Voltage

Code	Rated voltage
2E	DC250V
2J	DC630V
3A	DC1000V

Capacitance

The first two digits denote significant figures; the last digit denotes the multiplier of 10 in pF. ex.) In case of 101

$$10 \times 10^1 = 100 pF$$

• Capacitance Tolerance

Code	Capacitance Tolerance
J	+/-5%

• Dimension (LxW)

Please refer to [Part number list].

• Lead Style

*Lead wire is "solder coated CP wire".

Code	Lead Style	Lead spacing (mm)
B1	Straight type	5.0+/-0.8
E1	Straight taping type	5.0+0.6/-0.2
K1	Inside crimp type	5.0+/-0.8
M1	Inside crimp taping type	5.0+0.6/-0.2

Individual Specification

Murata's control code.

Please refer to [Part number list].

Package

Code	Package
Α	Taping type of Ammo
В	Bulk type

3. Marking

Temp. char. : Letter code : U (U2J Char.)
Capacitance : Actual numbers (Less than 100pF)

3 digit numbers (100pF and over)

Capacitance tolerance : Code

Rated voltage : Letter code : 4 (DC250V. Except dimension code : 1)

Letter code: 7 (DC630V) Letter code: A (DC1000V)

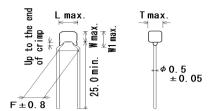
Company name code : Abbreviation : (Except dimension code : 1)

(Ex.)

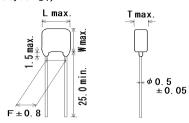
Ex.)			
Rated voltage Dimension code	DC250V	DC630V	DC1000V
1	U 102J	-	-
2	(M ₁₀₃)	€ 472	(M JAU
3,4	6 473 J4U	(M103 J7U	G 472 JAU
5	_	6 333 J7U	(M) 103 JAU

4. Part number list

- Inside Crimp (Lead Style:K*)



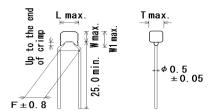
• Straight Long (Lead Style: B1)



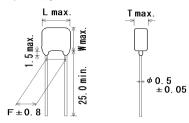
Unit: mm

Customer	Mirroto Dort Number	т.с	DC Rated	Con	Cap.		Dime	ension ((mm)		Dimension	Pack
Part Number	Murata Part Number	T.C.	Volt. (V)	Сар.	Tol.	L	W	W1	F	Т	(LxW) Lead Style	qty. (pcs)
	RCE7U2E101J1K1H03B	U2J	250	100pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E151J1K1H03B	U2J	250	150pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E221J1K1H03B	U2J	250	220pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E331J1K1H03B	U2J	250	330pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E471J1K1H03B	U2J	250	470pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E681J1K1H03B	U2J	250	680pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E102J1K1H03B	U2J	250	1000pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E152J1K1H03B	U2J	250	1500pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E222J1K1H03B	U2J	250	2200pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E332J1K1H03B	U2J	250	3300pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E472J1K1H03B	U2J	250	4700pF	±5%	4.0	3.5	5.0	5.0	3.15	1K1	500
	RCE7U2E682J2K1H03B	U2J	250	6800pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2E103J2K1H03B	U2J	250	10000pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J100J2K1H03B	U2J	630	10pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J150J2K1H03B	U2J	630	15pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J220J2K1H03B	U2J	630	22pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J330J2K1H03B	U2J	630	33pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J470J2K1H03B	U2J	630	47pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J680J2K1H03B	U2J	630	68pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J101J2K1H03B	U2J	630	100pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J151J2K1H03B	U2J	630	150pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J221J2K1H03B	U2J	630	220pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J331J2K1H03B	U2J	630	330pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J471J2K1H03B	U2J	630	470pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J681J2K1H03B	U2J	630	680pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J102J2K1H03B	U2J	630	1000pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J152J2K1H03B	U2J	630	1500pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J222J2K1H03B	U2J	630	2200pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J332J2K1H03B	U2J	630	3300pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J472J2K1H03B	U2J	630	4700pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U2J682J3K1H03B	U2J	630	6800pF	±5%	5.5	5.0	7.5	5.0	4.0	3K1	500
	RCE7U2J103J3K1H03B	U2J	630	10000pF	±5%	5.5	5.0	7.5	5.0	4.0	3K1	500
	RCE7U2J153J4K1H03B	U2J	630	15000pF	±5%	7.5	5.5	8.0	5.0	4.0	4K1	500
	RCE7U2J223J4K1H03B	U2J	630	22000pF	±5%	7.5	5.5	8.0	5.0	4.0	4K1	500
	RCE7U2J333J5B1H03B	U2J	630	33000pF	±5%	7.5	8.0	-	5.0	4.0	5B1	500
	RCE7U2J473J5B1H03B	U2J	630	47000pF	±5%	7.5	8.0	-	5.0	4.0	5B1	500

·Inside Crimp (Lead Style:K*)



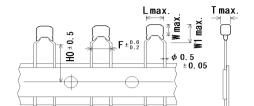
• Straight Long (Lead Style: B1)



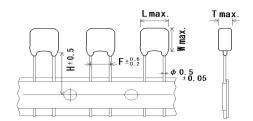
Unit : mm

Customer	Murata Part Number	T.C.	DC Rated	Cap.	Сар.	Dimension (mm) Dimension (LxW)						
Part Number		1.0.	Volt. (V)	Сар.	Tol.	L	W	W1	F	Т	Lead Style	qty. (pcs)
	RCE7U3A100J2K1H03B	U2J	1000	10pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A150J2K1H03B	U2J	1000	15pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A220J2K1H03B	U2J	1000	22pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A330J2K1H03B	U2J	1000	33pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A470J2K1H03B	U2J	1000	47pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A680J2K1H03B	U2J	1000	68pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A101J2K1H03B	U2J	1000	100pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A151J2K1H03B	U2J	1000	150pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A221J2K1H03B	U2J	1000	220pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A331J2K1H03B	U2J	1000	330pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A471J2K1H03B	U2J	1000	470pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A681J2K1H03B	U2J	1000	680pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A102J2K1H03B	U2J	1000	1000pF	±5%	5.5	4.0	6.0	5.0	3.15	2K1	500
	RCE7U3A152J3K1H03B	U2J	1000	1500pF	±5%	5.5	5.0	7.5	5.0	4.0	3K1	500
	RCE7U3A222J3K1H03B	U2J	1000	2200pF	±5%	5.5	5.0	7.5	5.0	4.0	3K1	500
	RCE7U3A332J4K1H03B	U2J	1000	3300pF	±5%	7.5	5.5	8.0	5.0	4.0	4K1	500
	RCE7U3A472J4K1H03B	U2J	1000	4700pF	±5%	7.5	5.5	8.0	5.0	4.0	4K1	500
	RCE7U3A682J5B1H03B	U2J	1000	6800pF	±5%	7.5	8.0	-	5.0	4.0	5B1	500
	RCE7U3A103J5B1H03B	U2J	1000	10000pF	±5%	7.5	8.0	-	5.0	4.0	5B1	500

Inside Crimp Taping (Lead Style: M*)



•Straight Taping (Lead Style:E*)

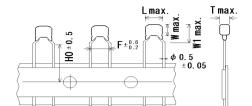


Unit : mm

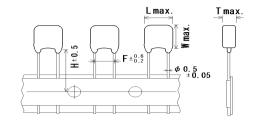
Customer			DC Rated		Cap.		D	imensi	on (mr	n)		Dimension	Pac
Part Number	Murata Part Number	T.C.	Volt. (V)	Сар.	Сар. Tol.	L	W	W1	F	Т	H/H0	(LxW) Lead Style	qty (pc:
	RCE7U2E101J1M1H03A	U2J	250	100pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	200
	RCE7U2E151J1M1H03A	U2J	250	150pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	200
	RCE7U2E221J1M1H03A	U2J	250	220pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	200
	RCE7U2E331J1M1H03A	U2J	250	330pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E471J1M1H03A	U2J	250	470pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E681J1M1H03A	U2J	250	680pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E102J1M1H03A	U2J	250	1000pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E152J1M1H03A	U2J	250	1500pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E222J1M1H03A	U2J	250	2200pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E332J1M1H03A	U2J	250	3300pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E472J1M1H03A	U2J	250	4700pF	±5%	4.0	3.5	5.0	5.0	3.15	16.0	1M1	20
	RCE7U2E682J2M1H03A	U2J	250	6800pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2E103J2M1H03A	U2J	250	10000pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J100J2M1H03A	U2J	630	10pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J150J2M1H03A	U2J	630	15pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J220J2M1H03A	U2J	630	22pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J330J2M1H03A	U2J	630	33pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J470J2M1H03A	U2J	630	47pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J680J2M1H03A	U2J	630	68pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J101J2M1H03A	U2J	630	100pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J151J2M1H03A	U2J	630	150pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J221J2M1H03A	U2J	630	220pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J331J2M1H03A	U2J	630	330pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J471J2M1H03A	U2J	630	470pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J681J2M1H03A	U2J	630	680pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J102J2M1H03A	U2J	630	1000pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J152J2M1H03A	U2J	630	1500pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J222J2M1H03A	U2J	630	2200pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J332J2M1H03A	U2J	630	3300pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J472J2M1H03A	U2J	630	4700pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	20
	RCE7U2J682J3M1H03A	U2J	630	6800pF	±5%	5.5	5.0	7.5	5.0	4.0	16.0	3M1	20
	RCE7U2J103J3M1H03A	U2J	630	10000pF	±5%	5.5	5.0	7.5	5.0	4.0	16.0	3M1	20
	RCE7U2J153J4M1H03A	U2J	630	15000pF	±5%	7.5	5.5	8.0	5.0	4.0	16.0	4M1	1:
	RCE7U2J223J4M1H03A	U2J	630	22000pF	±5%	7.5	5.5	8.0	5.0	4.0	16.0	4M1	15
	RCE7U2J333J5E1H03A	U2J	630	33000pF	±5%	7.5	8.0	-	5.0	4.0	17.5	5E1	15
	RCE7U2J473J5E1H03A	U2J	630	47000pF	±5%	7.5	8.0	-	5.0	4.0	17.5	5E1	15

PNLIST

Inside Crimp Taping (Lead Style: M*)



•Straight Taping (Lead Style:E*)



Unit : mm

Customer	Murata Part Number	T.C.	DC Rated	Сар.	Сар.		D	Dimension (LxW)	qty.				
Part Number		1.0.	Volt. (V)		Tol.	L	W	W1	F	Т	H/H0	Lead Style	
	RCE7U3A100J2M1H03A	U2J	1000	10pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A150J2M1H03A	U2J	1000	15pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A220J2M1H03A	U2J	1000	22pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A330J2M1H03A	U2J	1000	33pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A470J2M1H03A	U2J	1000	47pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A680J2M1H03A	U2J	1000	68pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A101J2M1H03A	U2J	1000	100pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A151J2M1H03A	U2J	1000	150pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A221J2M1H03A	U2J	1000	220pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A331J2M1H03A	U2J	1000	330pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A471J2M1H03A	U2J	1000	470pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A681J2M1H03A	U2J	1000	680pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A102J2M1H03A	U2J	1000	1000pF	±5%	5.5	4.0	6.0	5.0	3.15	16.0	2M1	2000
	RCE7U3A152J3M1H03A	U2J	1000	1500pF	±5%	5.5	5.0	7.5	5.0	4.0	16.0	3M1	2000
	RCE7U3A222J3M1H03A	U2J	1000	2200pF	±5%	5.5	5.0	7.5	5.0	4.0	16.0	3M1	2000
	RCE7U3A332J4M1H03A	U2J	1000	3300pF	±5%	7.5	5.5	8.0	5.0	4.0	16.0	4M1	1500
	RCE7U3A472J4M1H03A	U2J	1000	4700pF	±5%	7.5	5.5	8.0	5.0	4.0	16.0	4M1	1500
	RCE7U3A682J5E1H03A	U2J	1000	6800pF	±5%	7.5	8.0	-	5.0	4.0	17.5	5E1	1500
	RCE7U3A103J5E1H03A	U2J	1000	10000pF	±5%	7.5	8.0	-	5.0	4.0	17.5	5E1	1500

	C-Q200 Murata Standard Specifica AEC-Q200		Specification	AEC-Q200 Test Method					
		t Item							
	Pre-and Post-S Electrical Test	Stress		-					
2	High	Appearance	No defects or abnormalities.	Sit the capacitor for 1000±12h at 150±3°C. Let sit for 24±2h at					
	Temperature	Capacitance	Within ±3% or ±0.3pF	*room condition, then measure.					
	Exposure	Change	(Whichever is larger)						
	(Storage)	Q	30pF ≤ C : Q ≥ 350						
	. ,		10pF ≦ C < 30pF : Q ≧ 275+5C/2						
			10pF > C : Q ≧ 200+10C						
			100.						
			C : Nominal Capacitance (pF)						
		I.R.	More than 1,000MΩ or 50 MΩ•μF	\dashv					
		1.13.	· ·						
3	Temperature	Appearance	(Whichever is smaller) No defects or abnormalities. Perform the 1000 cycles according to the four heat treatments liste						
	Cycling	Capacitance	Within ±5% or ±0.5pF	Perform the 1000 cycles according to the four heat treatments listed in the following table. Let sit for 24±2 h at *room condition, then measure.					
	Cycling	Change	(Whichever is larger)	the following table. Let sit for 24±2 if at 100m condition, then measure.					
		Q	30pF ≤ C : Q ≥ 350	Step 1 2 3 4					
		Q	·						
			$10pF \le C < 30pF : Q \ge 275+5C/2$	Temp. (°C) -55+0/-3 Room Temp. 125+3/-0 Room Temp.					
			10pF > C : Q ≧ 200+10C						
			O . Naminal Canasitanas (nF)	Time (min.) 15±3 1 15±3 1					
			C : Nominal Capacitance (pF)	()					
		I.R.	1,000MΩ or 50MΩ•μF min.						
_			(Whichever is smaller)						
	Moisture	Appearance	No defects or abnormalities	Apply the 24h heat (25 to 65°C) and humidity (80 to 98%)					
	Resistance	Capacitance	Within ±5% or ± 0.5pF	treatment shown below, 10 consecutive times.					
		Change	(Whichever is larger)	Let sit for 24±2 h at *room condition, then measure.					
		Q	30pF ≤ C : Q ≥ 200	Temperature Humidity Humidity 80~98% Humidity 80~98% Humidity					
			30pF > C : Q ≧ 100+10C/3	(°C) Humidity 90-98% W 90-98% W 90-98% N 90-98%					
				65					
			C : Nominal Capacitance (pF)	60					
		I.R.	500MΩ or 25MΩ•μF min.	55					
			(Whichever is smaller)	950 E45					
				810					
				[[35 					
				30 11 11 11 11 11 11 11 11 11 11 11 11 11					
				25 20 +10					
				15 - 2 °C					
				10 Initial measurement					
				5					
				0 -5					
				-10 One cycle 24 hours					
				0 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 2 Hours					
5	Biased	Appearance	No defects or abnormalities	Apply the rated voltage and DC1.3+0.2/-0V (add $100k\Omega$ resistor)					
	Humidity	Capacitance	Within ±5% or ± 0.5pF	at 85±3°C and 80 to 85% humidity for 1000±12h.					
	,	Change	(Whichever is larger)	Remove and let sit for 24±2 h at *room condition, then measure.					
		Q	30pF ≦ C : Q ≧ 200	The charge/discharge current is less than 50mA.					
			30pF > C : Q ≧ 100+10C/3						
			·						
			C : Nominal Capacitance (pF)						
		I.R.	500MI or 25MI in min.						
		I.R.	500MΩ or 25MΩ•μF min. (Whichever is smaller)						
room	ı condition" T		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
oom	n condition" To		· ·	tmosphere pressure : 86 to 106kPa					
room	n condition" To		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
room	n condition" To		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
room	n condition" T		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
room	n condition" T		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
roon	n condition" T		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
roon	n condition" T		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
roon	n condition" T		(Whichever is smaller)	tmosphere pressure : 86 to 106kPa					
roon	n condition" T		(Whichever is smaller)	stmosphere pressure : 86 to 106kPa					

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Reference only									
No.		-Q200 t Item	Specification	AEC-Q200 Test Method					
6	Operational	Appearance	No defects or abnormalities.	Apply voltage in Table for 1000±12h at 125±3°C.					
	Life	Capacitance	Within ±3% or ±0.3pF	Let sit for 24±2 h at *room condition, then measure. The charge/discharge current is less than 50mA.					
		Change	(Whichever is larger)						
		Q	30pF ≤ C : Q ≥ 350						
			10pF ≤ C < 30pF : Q ≥ 275+5C/2	Rated Voltage Test Voltage					
			10pF > C : Q ≥ 200+10C	DC250V 150% of the rated voltage					
			10pi + 0 : Q = 200 · 100	DC630V 4200V - f th					
			C : Nominal Capacitance (pF)	DC1000V 120% of the rated voltage					
		I.R.	1,000MΩ or 50MΩ•μF min.						
		I.IX.	(Whichever is smaller)						
7	External Visua	<u> </u>		Visual in an action					
			No defects or abnormalities.	Visual inspection.					
8 9	Physical Dime	ISION	Within the specified dimensions.	Using calipers and micrometers.					
10	Marking Resistance	Annograpas	To be easily legible.	Visual inspection. Per MIL-STD-202 Method 215					
10		Appearance	No defects or abnormalities.						
	to Solvents	Capacitance	Within the specified tolerance.	Solvent 1 : 1 part (by volume) of isopropyl alcohol					
		Q	$30pF \le C : Q \ge 1,000$	3 parts (by volume) of mineral spirits					
			30pF > C : Q ≧ 400+20C	Solvent 2 : Terpene defluxer					
				Solvent 3 : 42 parts (by volume) of water					
			C : Nominal Capacitance (pF)	1 part (by volume) of propylene glycol					
		I.R.	More than 10,000MΩ or 500 MΩ∙μF	monomethyl ether					
			(Whichever is smaller)	1 part (by volume) of monoethanolamine					
11	Mechanical	Appearance	No defects or abnormalities.	Three shocks in each direction should be applied along 3					
	Shock	Capacitance	Within the specified tolerance.	mutually perpendicular axes of the test specimen (18 shocks).					
		Q	30pF ≦ C : Q ≧ 1,000	The specified test pulse should be Half-sine and should have a					
			30pF > C : Q ≧ 400+20C	duration : 0.5ms, peak value : 1500G and velocity change : 4.7m/s.					
			C : Nominal Capacitance (pF)						
12	Vibration	Appearance	No defects or abnormalities.	The capacitor should be subjected to a simple harmonic motion					
		Capacitance	Within the specified tolerance.	having a total amplitude of 1.5mm, the frequency being varied					
		Q	30pF ≤ C : Q ≥ 1,000	uniformly between the approximate limits of 10 and 2,000Hz.					
			30pF > C : Q ≧ 400+20C	The frequency range, from 10 to 2000Hz and return to 10Hz,					
				should be traversed in approximately 20 min. This motion					
			C : Nominal Capacitance (pF)	should be applied for 12 items in each 3 mutually perpendicular					
				directions (total of 36 times).					
13-1	Resistance	Appearance	No defects or abnormalities.	The lead wires should be immersed in the melted solder 1.5 to 2.0mm					
	to Capacitance		Within ±2.5% or ±0.25pF	from the root of terminal at 260±5°C for 10±1 seconds.					
	Soldering	Change	(Whichever is larger)	Post-treatment					
	Heat	Dielectric	No defects	Capacitor should be stored for 24±2 hours at *room condition.					
	(Non-	Strength							
	Preheat)	(Between							
		terminals)							
13-2	Resistance	Appearance	No defects or abnormalities.	First the capacitor should be stored at 120+0/-5°C for 60+0/-5 seconds.					
	to	Capacitance	Within ±2.5% or ±0.25pF	Then, the lead wires should be immersed in the melted solder 1.5 to					
	Soldering	Change	(Whichever is larger)	2.0mm from the root of terminal at 260±5°C for 7.5+0/-1 seconds.					
	Heat	Dielectric	No defects						
	(On-	Strength		Post-treatment					
	Preheat)	(Between		Capacitor should be stored for 24±2 hours at *room condition.					
		terminals)							
13-3	Resistance	,		Test condition					
	Ī.		Within ±2.5% or ±0.25pF	Temperature of iron-tip: 350±10°C					
	to	Capacitance		1 .					
	to Soldering	Capacitance Change	(Whichever is larger)	Soldering time: 3.5±0.5 seconds					
			(Whichever is larger) No defects	Soldering time: 3.5±0.5 seconds Soldering position					
	Soldering	Change		–					
	Soldering Heat	Change Dielectric		Soldering position					
	Soldering Heat (soldering	Change Dielectric Strength		Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal.					
	Soldering Heat (soldering	Change Dielectric Strength (Between		Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal.					
	Soldering Heat (soldering	Change Dielectric Strength (Between		Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend.					
14	Soldering Heat (soldering	Change Dielectric Strength (Between		Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals)	No defects	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition.					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals) Appearance Capacitance	No defects No defects or abnormalities. Within ±5% or ±0.5pF	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals)	No defects No defects or abnormalities. Within ±5% or ±0.5pF (Whichever is larger)	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2 h at *room condition, then measure.					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals) Appearance Capacitance Change	No defects No defects or abnormalities. Within ±5% or ±0.5pF (Whichever is larger) 30pF ≤ C: Q ≥ 350	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2 h at					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals) Appearance Capacitance Change	No defects No defects or abnormalities. Within $\pm 5\%$ or $\pm 0.5 pF$ (Whichever is larger) $30pF \le C : Q \ge 350$ $10pF \le C < 30pF : Q \ge 275 + 5C/2$	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2 h at *room condition, then measure. Step 1 2 Temp. =55±0/-3 125±3/-0					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals) Appearance Capacitance Change	No defects No defects or abnormalities. Within ±5% or ±0.5pF (Whichever is larger) 30pF ≤ C: Q ≥ 350	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2 h at *room condition, then measure. Step 1 2					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals) Appearance Capacitance Change	No defects No defects or abnormalities. Within $\pm 5\%$ or $\pm 0.5 pF$ (Whichever is larger) $30pF \le C : Q \ge 350$ $10pF \le C < 30pF : Q \ge 275+5C/2$ $10pF > C : Q \ge 200+10C$	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2 h at *room condition, then measure. Step 1 2 Temp. (°C) -55+0/-3 125+3/-0 Time 15±3 15±3					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals) Appearance Capacitance Change Q	No defects or abnormalities. Within $\pm 5\%$ or ± 0.5 pF (Whichever is larger) 30 pF \leq C : Q \geq 350 10 pF \leq C < 30 pF : Q \geq 275+5C/2 10 pF > C : Q \geq 200+10C	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2 h at *room condition, then measure. Step 1 2 Temp. (°C) -55+0/-3 125+3/-0					
14	Soldering Heat (soldering iron method)	Change Dielectric Strength (Between terminals) Appearance Capacitance Change	No defects No defects or abnormalities. Within $\pm 5\%$ or $\pm 0.5 pF$ (Whichever is larger) $30pF \le C : Q \ge 350$ $10pF \le C < 30pF : Q \ge 275+5C/2$ $10pF > C : Q \ge 200+10C$	Soldering position Straight Lead: 1.5 to 2.0mm from the root of terminal. Crimp Lead: 1.5 to 2.0mm from the end of lead bend. • Post-treatment Capacitor should be stored for 24±2 hours at *room condition. Perform the 300 cycles according to the two heat treatments listed in the following table (Maximum transfer time is 20s.). Let sit for 24±2 h at *room condition, then measure. Step 1 2 Temp. (°C) -55+0/-3 125+3/-0 Time 15±3 15±3					

* "room cond ESRCE04D

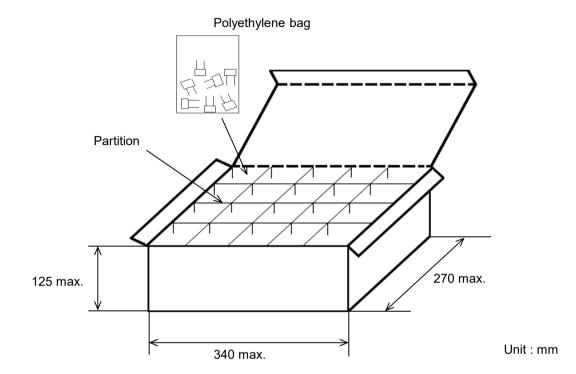
	Reference only						
No.	AEC-Q200		Specifications		AEC-Q200 Test Method		
15	Test Item ESD Appearance		No defects or abnormalities.		Per AEC-Q200-002		
15	E3D		+		Pel AEC-Q200-002		
		Capacitance		specified tolerance.			
		Q	1 '	Q ≥ 1,000			
			30pF > C :	Q ≧ 400+20C			
				Capacitance (pF)	_		
		I.R.		10,000MΩ or 500MΩ∙μF			
			`	r is smaller)			
16	Solderability		Lead wire should be soldered with uniform coating on the axial direction over 95% of the circumferential direction.		Should be placed into steam aging for 8h±15 min.		
					The terminal of capacitor is dipped into a solution of ethanol (JIS K 8101) and rosin (JIS K 5902) (25% rosin in weight propotion). Immerse in solder solution for 2±0.5 seconds.		
					In both cases the depth of dipping is up to about 1.5 to 2mm from the		
					terminal body.		
					Temp. of solder :		
			1		245±5°C Lead Free Solder (Sn-3.0Ag-0.5Cu)		
					235±5°C H60A or H63A Eutectic Solder		
17	Electrical	Appearance			Visual inspection.		
	Characte-	Capacitance		Within the specified tolerance. The capacitance, Q should be measured at 25			
	rization	Q	30pF ≤ C : Q ≥ 1,000		voltage shown in the table.		
			30pF > C :	Q ≧ 400+20C	Nominal Cap. Frequency Voltage		
			L		$C \le 1000 pF$ 1±0.1MHz AC0.5 to 5V(r.m.s.)		
			C : Nomina	I Capacitance (pF)	C > 1000pF 1±0.1kHz AC1±0.2V(r.m.s.)		
		<u></u>	<u> </u>				
		I.R.	Between	10,000MΩ or 500MΩ•μF min.	The insulation resistance should be measured with DC500V		
			Terminals	(Whichever is smaller)	(DC250V in case of rated voltage : DC250V) at 25 °C within 2 min.		
					of charging.		
		Dielectric	Between	No defects or abnormalities.	The capacitor should not be damaged when voltage in Table is		
		Strength	Terminals	applied between the terminations for 1 to 5 seconds.			
				(Charge/Discharge current ≦ 50mA.)			
				Rated Voltage Test Voltage			
				DC250V 200% of the rated voltage			
				DC630V 150% of the rated voltage DC1000V 130% of the rated voltage			
				The congestor is pleased in a container with motel halls of 1mm			
			Body No defects or abnormalities. Insulation	The capacitor is placed in a container with metal balls of 1mm diameter so that each terminal, short-circuit is kept approximately 2mm from the balls, and 200% of the rated DC voltage (130% of the rated voltage in case of rated voltage: DC630V,DC1000V) is impressed for 1 to 5 seconds between capacitor terminals and metal balls.			
					(Charge/Discharge current ≤ 50mA.)		
18	Terminal Tensile		Termination not to be broken or loosened.		As in the figure, fix the capacitor body, apply the force gradually		
	Strength	Strength			to each lead in the radial direction of the capacitor until reaching 10N		
					and then keep the force applied for 10±1 seconds.		
					位.		
	Bending Strength		•		Each lead wire should be subjected to a force of 2.5N and then		
					be bent 90° at the point of egress in one direction. Each wire is then		
					returned to the original position and bent 90° in the opposite		
					direction at the rate of one bend per 2 to 3 seconds.		
19	Capacitance		Within the specified Tolerance		The capacitance change should be measured after 5min. at		
	Temperature Characteristics		25°C to 125°C : -750±120 ppm/°C -55°C to 25°C : -750+120/-347 ppm/°C		each specified temperature step.		
					Step Temperature(°C)		
					1 25±2		
					2 -55±3		
					3 25±2		
					4 125±3 5 25±2		
					The temperature coefficient is determined using the capacitance		
					measured in step 3 as a reference. When cycling the temperature		
					sequentially from step 1 through 5 (-55°C to 125°C)		
					the capacitance should be within the specified tolerance for the		
					temperature coefficient and capacitance change as Table A.		
					The capacitance drift is calculated by dividing the differences		
					between the maximum and minimum measured values in the step		
* "roo	n condition" ^T	emnerature · 1	5 to 35°C . ₽≏	lative humidity : 45 to 75% Atmos	1, 3 and 5 by the capacitance value in step 3.		
100	room condition" Temperature : 15 to 35°C, Relative humidity : 45 to 75%, Atmosphere pressure : 86 to 106kPa						

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6. Packing specification

•Bulk type (Packing style code : B)

The size of packing case and packing way



The number of packing = *1 Packing quantity × *2 n

*1 : Please refer to [Part number list].

*2 : Standard n = 20 (bag)

Note)

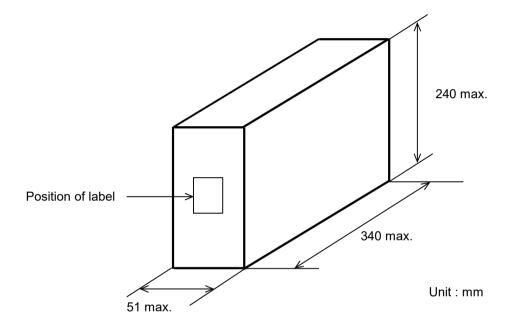
The outer package and the number of outer packing be changed by the order getting amount.

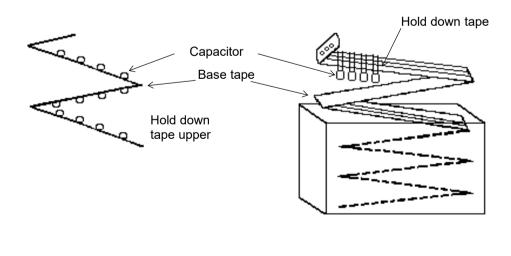
JKBCRPE02

·Ammo pack taping type (Packing style code : A)

A crease is made every 25 pitches, and the tape with capacitors is packed zigzag into a case. When body of the capacitor is piled on other body under it.

The size of packing case and packing way





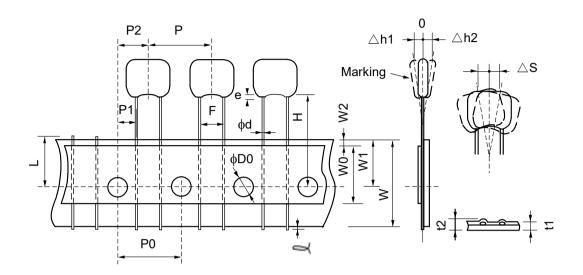
EKTRPE01

7. Taping specification

7-1. Dimension of capacitors on tape

Straight taping type < Lead Style : E1 >

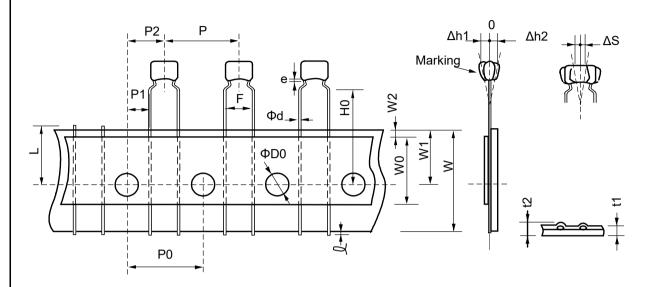
Pitch of component 12.7mm / Lead spacing 5.0mm



Unit: mm

Item	Code	Dimensions	Remarks	
Pitch of component		12.7+/-1.0		
Pitch of sprocket hole	P0	12.7+/-0.2		
Lead spacing	F	5.0+0.6/-0.2		
Length from hole center to component center	P2	6.35+/-1.3	Deviation of progress direction	
Length from hole center to lead	P1	3.85+/-0.7		
Deviation along tape, left or right defect	ΔS	0+/-2.0	They include deviation by lead bend	
Carrier tape width	W	18.0+/-0.5		
Position of sprocket hole	W1	9.0+0/-0.5	Deviation of tape width direction	
For straight lead type	Н	17.5+/-0.5		
Protrusion length	L	0.5 max.		
Diameter of sprocket hole	ФD0	4.0+/-0.1		
Lead diameter	Фd	0.5+/-0.05		
Total tape thickness	t1	0.6+/-0.3	They include hold down tape	
Total thickness of tape and lead wire	t2	1.5 max.	thickness.	
Deviation agrees tand	∆h1	2.0 max. (Dimension code : U)		
Deviation across tape	∆h2	1.0 max. (except as above)		
Portion to cut in case of defect	L	11.0+0/-1.0		
Hold down tape width	W0	9.5 min.		
Hold down tape position	W2	1.5+/-1.5		
Coating extension on lead		2.0 max. (Dimension code : U)		
Coating extension on lead	е	1.5 max. (exce	pt as above)	

Inside crimp taping type < Lead Style : M1 > Pitch of component 12.7mm / Lead spacing 5.0mm

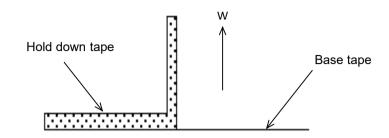


Unit : mm

Item		Dimensions	Remarks	
Pitch of component		12.7+/-1.0		
Pitch of sprocket hole	P0	12.7+/-0.2		
Lead spacing	F	5.0+0.6/-0.2		
Length from hole center to component center	P2	6.35+/-1.3	Deviation of progress direction	
Length from hole center to lead	P1	3.85+/-0.7		
Deviation along tape, left or right defect	ΔS	0+/-2.0	They include deviation by lead bend	
Carrier tape width	W	18.0+/-0.5		
Position of sprocket hole	W1	9.0+0/-0.5	Deviation of tape width direction	
Lead distance between reference and bottom plane	H0	16.0+/-0.5		
Protrusion length	Q	0.5 max.		
Diameter of sprocket hole	ФD0	4.0+/-0.1		
Lead diameter	Фd	0.5+/-0.05		
Total tape thickness	t1	0.6+/-0.3	They include hold down tape	
Total thickness of tape and lead wire	t2	1.5 max.	thickness	
Deviation across tape	Δh1	2.0 max. (Dimension code : W)		
Deviation across tape	Δh2	1.0 max. (except as above)		
Portion to cut in case of defect	L	11.0+0/-1.0		
Hold down tape width	W0	9.5 min.		
Hold down tape position	W2	1.5+/-1.5		
Coating extension on lead		Up to the end of	crimp	

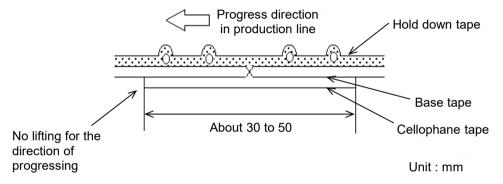
7-2. Splicing way of tape

1) Adhesive force of tape is over 3N at test condition as below.



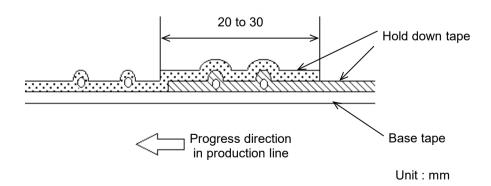
2) Splicing of tape

- a) When base tape is spliced
 - •Base tape shall be spliced by cellophane tape. (Total tape thickness shall be less than 1.05mm.)



b) When hold down tape is spliced

•Hold down tape shall be spliced with overlapping. (Total tape thickness shall be less than 1.05mm.)



- c) When both tape are spliced
 - •Base tape and hold down tape shall be spliced with splicing tape.

ETP2R01